Applicabl	e standard								
	Operating Temperature Range		-55 to +105°C (Note1)	Storag	Storage Temperature Range		-10 °C to +60°C (Note3)		
Rating	Operating Humidity Range		20% to 80% (Note2)	+ ĕ	torage Humidity Range		40% to 70% (Note3		
	Voltage		250 V AC/DC	UL·		Voltage	30 V AC/DC		,
	Current		AWG 22 to 24 : 2.0A AWG 26 : 1.5A	Rating		Current	2.0A		
				Applicable			DE51 04D0		
			AWG 28: 1.0A	Conne	ctor		DF51-24DS	-2C	
		AWG 30 : 0.5A	Applicable Contact		DF11-****SC(F)(#				
			Specificat	tions					
	Item		Test method			Requ	uirements	QT	AT
Construc	tion	1						1	
General Examination Visually and b		Visually and by	measuring instrument.		According to drawing.			Х	X
		Confirmed visua	,			1 , ,			Х
Electric C	Characteristics				•				
Contact Resistance Millivolt Level Method		20mV MAX, 1mA (DC or 1000Hz).			30 mΩ MAX.			X	_
Insulation F	Resistance	500 V DC.			1000 MΩ MIN.			Х	_
Voltage Proof		650 V AC for 1 min.			No flashover or breakdown.			Х	_
Mechanic	cal Characteris	stics							
Mechanical Operation		30 times insertion and extraction.			 Contact resistance: 30 m Ω MAX. No damage, crack or looseness of parts. 			Х	_
Mating and unmating force		It takes out and inserts with a conformity connector.			1.Insertion Force :104.2 N MAX. 2.Extraction Force :6.2 N MIN.			Х	_
Vibration		Frequency 10 to 55 Hz, single amplitude 0.75 mm, at			1.No electrical discontinuity of 1 μ s.			Х	_
		10 cycles for 3 directions.			2.No damage, crack or looseness of parts.				
Shock		Acceleration 490 m/s ² duration of pulse 11 ms at 3 times for 3 directions.			!			Х	-
Environa	nental Charact		ctions.						
Damp Heat			± 2°C , humidity 90 to 95 %,	96 h	1 Cont	act resistance:	30 m () MAX	X	1 _
(Steady State)		(After leaving the room temperature for 1 to 2h.)			 2.Insulation resistance: 500 MΩ MIN. 3.No damage, crack or looseness of parts. 				
Rapid Char	nge Of	Temperature -	.55°C→ +105°C			arriage, crack or act resistance:		X	 _
Temperature		Time 30min → 30min			2.Insulation resistance: 1000 M Ω MIN.			^`	
		Under 5 Cycles			3.No da	amage, crack or	looseness of parts.		
			ng time of the tank is 2 to 3 MI						
Dry Heat			e room temperature for 1 to 2b	1.)	1 Contr	act recistance:	20 m () MAY	X	
Diy Heat		Exposed at 105±2°C, 96h			1.Contact resistance: 30 m Ω MAX.2.Insulation resistance: 1000 MΩ MIN.			^	
							looseness of parts.		
Cold		Exposed at -	-55±3°C, 96h		1.Conta	act resistance:	30 m Ω MAX.	Х	-
						ation resistance:			
i					3.NO da	amage, crack or	looseness of parts.		

Note 1:Include the temperature rising by current. Note 2:No condensing

Note 3:Apply to the condition of long term storage for unused products before mount on pcb,

After mounted on pcb, operating temperature and humidity range is applied for interim storage during transportation.

	COUNT	DESCRIPTION OF REVISIONS	DESCRIPTION OF REVISIONS DESIGNED		CHECKED		
$\sqrt{3}$	2	DIS-H-00005270	TS. MIYAKI		SZ. 0N0	20190912	
				APPROVE	ED HS. OKAWA	20180403	
				CHECKE	D ST. WADA	20180403	
				DESIGNE	TH. SATO	20180403	
Unles	s otherwise	e specified, refer to IEC 60512.		DRAWN	TH. SATO	20180403	
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DRAWING NO.		ELC-363513-00-00		
н	ড _	SPECIFICATION SHEET	PART NO. DF51A-24DP-2DSA				
11.0		HIROSE ELECTRIC CO., LTD.	CODE NO.	CL5	43-5053-0-00	1/2	

	Specifica	ations	5				
Item	Test method			Requi	rements	QT	АТ
Resistance To Soldering Heat	1)Solder bath method S Soldered at solder temperature, 260°C for in immersion, duration, 5 s. 2)Manual soldering Soldering iron temperature :270°C, Soldering time :3s. No strength on contact.			s impaired func	tion ,no deformation of eness of the terminals.	X	_
Solderability	Soldering temperature : 245°C Duration of immersion :soldering, for 5 sec.			m of 95 $\%$ of th	f solder shall cover e surface Being	Х	_
Note QT:Qualification Te	st AT:Assurance Test X:Applicable Test	Di	RAWIN	G NO.	ELC-363513-0	00-00)
	SPECIFICATION SHEET		PART NO.		DF51A-24DP-2DSA		
HS		PART	NO.	الاالا	-51A-24DP-2D5A		